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**ML9060**

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**1/2 DUTY, 160-OUTPUT STATIC LCD DRIVER**

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**GENERAL DESCRIPTION**

The ML9060 consists of a 320-bit shift register, a 320-bit data latch, 160 sets of LCD drivers, and a common signal generator circuit.

The LCD display data is input serially to the shift register from the DATA IN pin in synchronization with the CLOCK IN signal, and is stored in the data latch by the LOAD IN signal.

The LCD display data stored in the data latch is output via the LCD drivers.

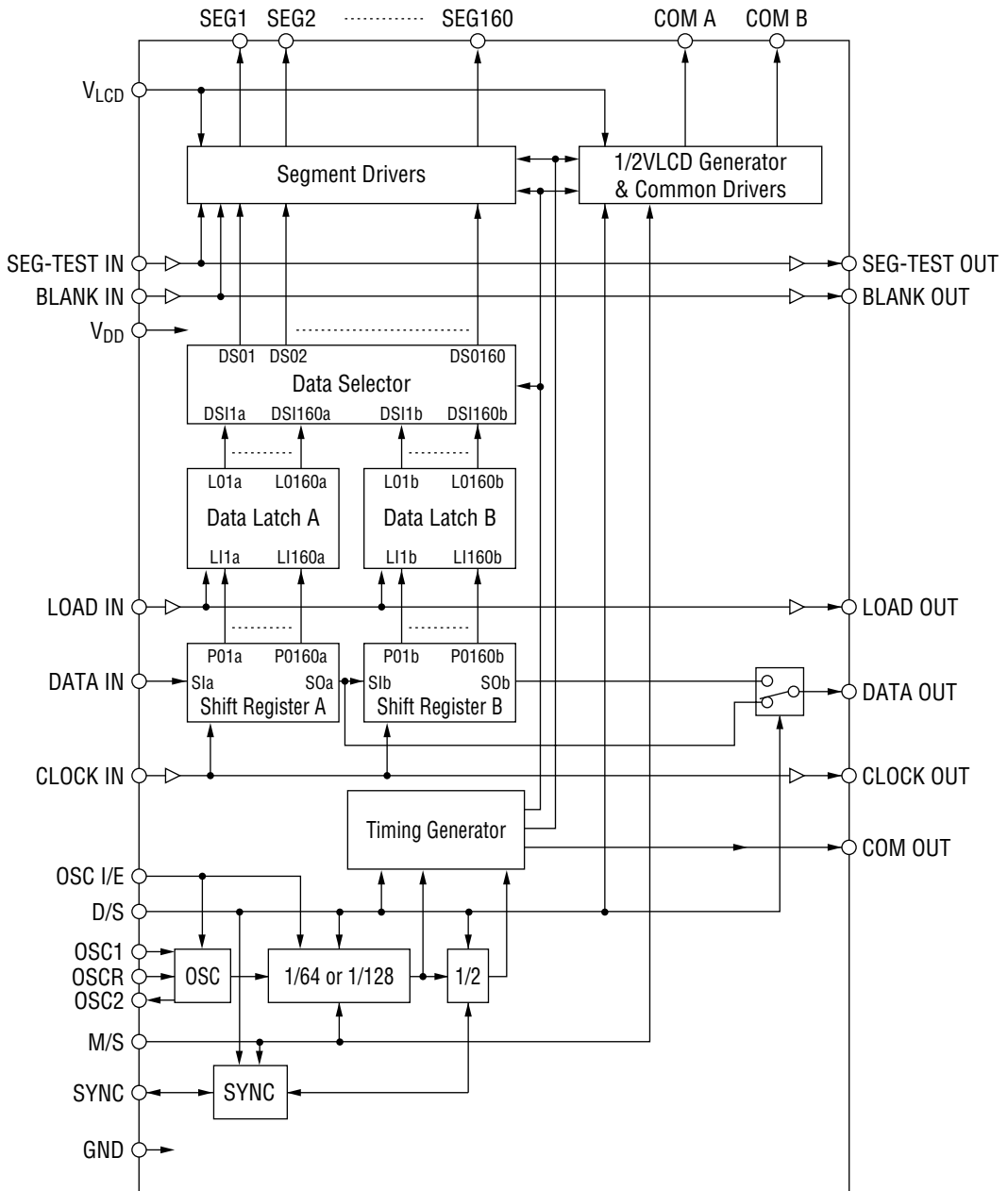
A maximum of 160 segments of LCD can be driven in static display mode and a maximum of 320 segments can be driven directly in the 1/2 duty display mode.

It is possible to select the mode of using the internal oscillator circuit or the mode of using an external clock for the common signal generator circuit. The ML9060 also outputs the sync signal during the 1/2 duty display mode.

**FEATURES**

- Logic power supply : 2.7 to 5.5V
- LCD Driving voltage : 4.5 to 16V
- Maximum number of segments that can be driven:
  - Static display mode : 160 segments
  - 1/2 Duty display mode : 320 segments
- Serial transfer clock : 1 MHz max.
- The microcontroller interface consists of the three signals DATA IN, CLOCK IN, and LOAD IN.
- An RC oscillator circuit is built in which can use either an external resistor or the internal resistor.
- Cascade connection of several ICs is possible. (Max. 3 chips)
- Built-in common signal generator circuit.
- Built-in common output mid-level voltage generator circuit.
- Input for turning all segments ON is available (SEG-TEST IN).
- Input for turning all segments OFF is available (BLANK IN).
- Gold bump chip                      Product name: ML9060DVWA

**BLOCK DIAGRAM**



**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Rating	Unit
Logic power supply voltage	$V_{DD}$	$T_a = 25^{\circ}\text{C}$	-0.3 to +6.5	V
LCD Driving voltage	$V_{LCD}$	$T_a = 25^{\circ}\text{C}$	0 to 18	V
Input voltage	$V_I$	$T_a = 25^{\circ}\text{C}$	GND-0.3 to $V_{DD}+0.3$	V
Storage temperature	$T_{STG}$	—	-55 to +150	$^{\circ}\text{C}$

**RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Condition	Range	Unit
Logic power supply voltage	$V_{DD}^*$	—	2.7 to 5.5	V
LCD Driving voltage	$V_{LCD}^*$	—	4.5 to 16	V
Junction operating temperature	$T_{jop}$	—	-40 to +85	$^{\circ}\text{C}$

\*: Use with  $V_{DD} \leq V_{LCD}$

Note: Never place a short between an output pin and another output pin or between an output pin and other pins (input pins, I/O pins, or power supply pins).

: In order to prevent malfunctioning of the device, turn on the logic power supply first and then turn on the LCD driving power supply, and also turn off the LCD driving power supply and then turn off the logic power supply.

**ELECTRICAL CHARACTERISTICS****DC Characteristics**(V<sub>DD</sub> = 2.7 to 5.5V, V<sub>LCD</sub> = 4.5 to 16V, T<sub>j</sub> = -40 to +85°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Applicable pin	
"H" Input voltage	V <sub>IH1</sub> *1	—	0.7V <sub>DD</sub>	—	V <sub>DD</sub>	V	DATA IN CLOCK IN LOAD IN	
	V <sub>IH2</sub> *2		0.8V <sub>DD</sub>	—	V <sub>DD</sub>			
"L" Input voltage	V <sub>IL1</sub> *1	—	GND	—	0.3V <sub>DD</sub>	V	SEG-TEST IN BLANK IN	
	V <sub>IL2</sub> *2		GND	—	0.2V <sub>DD</sub>			
Input leakage current 1	I <sub>L1</sub>	V <sub>I</sub> = V <sub>DD</sub> or 0V	—	—	±1.0	μA	M/S, D/S OSC1, OSC I/E	
Input leakage current 2	I <sub>L2</sub>	V <sub>I</sub> = V <sub>DD</sub> or 0V D/S = "H" M/S = "L"	—	—	±10	μA	SYNC	
"H" Output voltage	Segment	V <sub>OHS</sub>	I <sub>O</sub> = -30μA	V <sub>LCD</sub> -0.2	—	—	V	SEG1 to SEG160
	Common	V <sub>OHC</sub> *3	I <sub>O</sub> = -150μA	V <sub>LCD</sub> -0.2	—	—	V	COM A, COM B
	Logic	V <sub>OHL1</sub>	I <sub>O</sub> = -100μA	0.9V <sub>DD</sub>	—	—	V	DATA OUT CLOCK OUT LOAD OUT SEG-TEST OUT BLANK OUT COM OUT SYNC
		V <sub>OHL2</sub>	I <sub>O</sub> = -200μA	0.9V <sub>DD</sub>	—	—	V	OSC2
"M" Output voltage	Common	V <sub>OMC</sub> *3	I <sub>O</sub> = ±150μA	1/2V <sub>LCD</sub> -0.15	1/2V <sub>LCD</sub> +0.15	V	COM A, COM B	
"L" Output voltage	Segment	V <sub>OLS</sub>	I <sub>O</sub> = 30μA	—	—	0.2	V	SEG1 to SEG160
	Common	V <sub>OLC</sub> *3	I <sub>O</sub> = 150μA	—	—	0.2	V	COM A, COM B
	Logic	V <sub>OLL1</sub>	I <sub>O</sub> = 100μA	—	—	0.1V <sub>DD</sub>	V	DATA OUT CLOCK OUT LOAD OUT SEG-TEST OUT BLANK OUT COM OUT SYNC
		V <sub>OLL2</sub>	I <sub>O</sub> = 200μA	—	—	0.1V <sub>DD</sub>	V	OSC2
Output resistance	Segment	R <sub>SEG</sub>	—	—	10	kΩ	SEG1 to SEG160	
	Common	R <sub>COM</sub>	—	—	1.5	kΩ	COM A, COM B	

"M": Middle level

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Applicable pin
Static supply current	$I_{DD1}$	D/S = "L" (Static) Fix other input levels at either "H" or "L" Oscillator stopped No load	—	—	30	$\mu\text{A}$	$V_{DD}$
	$I_{DD2}$	D/S = "H" (1/2duty) Fix other input levels at either "H" or "L" Oscillator stopped No load	—	—	30	$\mu\text{A}$	$V_{DD}$
	$I_{LCD1}$	D/S = "L" (Static) Fix other input levels at either "H" or "L" Oscillator stopped No load	—	—	30	$\mu\text{A}$	$V_{LCD}$
	$I_{LCD2}$	D/S = "H" (1/2duty) Fix other input levels at either "H" or "L" Oscillator stopped No load	—	—	900	$\mu\text{A}$	$V_{LCD}$
Dynamic supply current *4	$I_{DD1}$	$V_{DD} = 5.5\text{V}$ D/S = "L" (Static) OSC1 is Open OSC2 is connected to OSCR Other inputs are "H" or "L" No load	—	—	3	$\text{mA}$	$V_{DD}$
	$I_{DD2}$	$V_{DD} = 5.5\text{V}$ D/S = "H" (1/2duty) OSC1 is Open OSC2 is connected to OSCR Other inputs are "H" or "L" No load	—	—	3	$\text{mA}$	$V_{DD}$
	$I_{LCD1}$	$V_{DD} = 5.5\text{V}$ D/S = "L" (Static) OSC1 is Open OSC2 is connected to OSCR Other inputs are "H" or "L" No load	—	—	200	$\mu\text{A}$	$V_{LCD}$
	$I_{LCD2}$	$V_{DD} = 5.5\text{V}$ D/S = "H" (1/2duty) OSC1 is Open OSC2 is connected to OSCR Other inputs are "H" or "L" No load	—	—	1	$\text{mA}$	$V_{LCD}$

\*1: Applicable to the DATA IN, LOAD IN, SEG-TEST IN, M/S, D/S, and OSC I/E pins.

\*2: Applicable to the CLOCK IN, OSC1, and BLANK IN pins.

\*3: Applicable to the voltage drop when the current flows into or out of one COM pin.

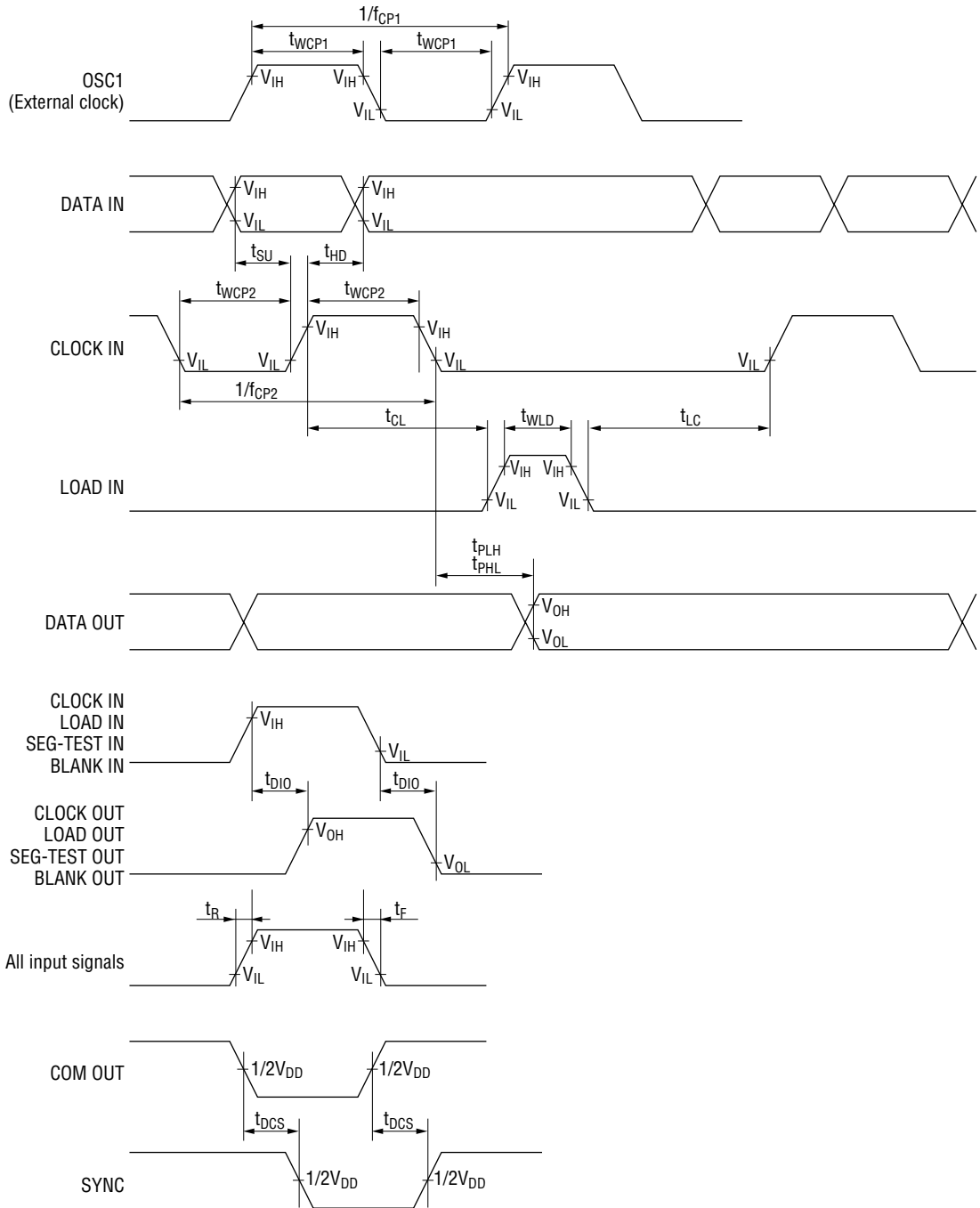
\*4: The LCD display data of "0" and "1" are input alternately.

## Switching Characteristics

(V<sub>DD</sub> = 2.7 to 5.5V, V<sub>LCD</sub> = 4.5 to 16V, T<sub>j</sub> = -40 to +85°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Applicable pin
OSC IN Clock frequency (external input)	f <sub>CP1</sub>	The clock is input to the OSC1 pin. The pins OSC2 and OSCR are left open. OSC I/E = "L"	—	—	25.6	kHz	OSC1
Clock pulse width (external input)	t <sub>WCP1</sub>		50	—	—	μs	OSC1
External Rf clock frequency (internal oscillations)	f <sub>OSC1</sub>	An Rf of 120k Ω ±2% is connected between OSC1 and OSC2. OSCR is left open. OSC I/E = "H"	2.0	8.5	15.0	kHz	OSC1, OSC2
Internal Rf clock frequency (with the built-in oscillator)	f <sub>OSC2</sub>	OSC1 open. OSC2 and OSCR shorted. OSC I/E tied to V <sub>DD</sub> or any "H" level.	7.7	12.8	20.5	kHz	OSC1, OSCR, OSC2
Data clock frequency	f <sub>CP2</sub>		—	—	1	MHz	CLOCK IN
Data clock pulse width	t <sub>WCP2</sub>		100	—	—	ns	CLOCK IN
Data setup time	t <sub>SU</sub>		50	—	—	ns	DATA IN
Data hold time	t <sub>HD</sub>		50	—	—	ns	CLOCK IN
CLOCK to LOAD Period	t <sub>CL</sub>		100	—	—	ns	CLOCK IN
LOAD to CLOCK Period	t <sub>LC</sub>		100	—	—	ns	LOAD IN
LOAD Pulse width	t <sub>WLD</sub>		100	—	—	ns	LOAD IN
CLOCK IN to DATA OUT delay time	t <sub>PLH</sub> t <sub>PHL</sub>	C <sub>L</sub> =15pF	—	—	70	ns	CLOCK IN DATA OUT
IN to OUT delay time	t <sub>DIO</sub>	No load	—	—	40	ns	CLOCK IN/OUT LOAD IN/OUT SEG-TEST IN/OUT BLANK IN/OUT
COM OUT to SYNC delay time	t <sub>DCS</sub>	C <sub>L</sub> =15pF	—	—	40	ns	COM OUT SYNC
Input signal rise time	t <sub>R</sub>		—	—	50	ns	All inputs other than the OSCR input
Input signal fall time	t <sub>F</sub>		—	—	50	ns	

**TIMING DIAGRAM**



## FUNCTIONAL DESCRIPTION

The ML9060 is an LCD driver LSI with an internal shift register and a set of internal data latches and is capable of driving LCD displays of up to 160 segments in the static mode or 320 segments in the 1/2 duty mode. The display data is read into the shift register serially from the DATA IN pin at the rising edge of the CLOCK IN input signal. The display data is transferred internally to the data latches at the High level of the LOAD IN input signal and is output to the segments via the segment drivers in this IC. The display data in the shift register is output via the DATA OUT pin in synchronization with the falling edge of the CLOCK IN input signal. The display data should be input in the sequence of SEG160, SEG159, ... , SEG2, SEG1 for proper display of data.

### Description of Pin Functions

- **M/S**

This is the input pin for selecting either the Master mode or the Slave mode. This LSI goes into the master mode when this pin is High and enters the Slave mode when this pin is Low.

- **D/S**

This input pin is for selecting either the dynamic display mode at 1/2 duty (D mode - "H" input) or the static display mode (S mode - "L" input).

Note that the internal bias resistor is made ON in the dynamic (D) mode and is turned OFF in the static mode (S).

- **OSC I/E**

This is the input pin for selecting whether to use the external clock input mode, or the internal Rf oscillation mode or the external Rf oscillation mode.

When this pin is tied to the "H" level, the internal Rf oscillation mode or the external Rf oscillation is used. When this pin is tied to the "L" level, the external clock input is used for the operation of the LSI.

In the slave mode of operation of this LSI, any input to this pin will be ignored. Hence, tie this pin to V<sub>DD</sub> or GND in the slave mode.

- **OSC1, OSCR, OSC2**

These are the pins for the oscillator for generating the common signal.

### In the Master mode (M/S pin = "H"):

It is possible to select from among the three modes - internal Rf oscillation mode, external Rf oscillation mode, and the external clock input mode. During the static display operation mode, a common signal with 1/128th the frequency of the clock oscillator is output via the COM OUT pin.

During the 1/2 duty dynamic display operation mode, a common signal with 1/64th the frequency of the clock oscillator is output via the COM OUT pin.

- Internal Rf oscillation mode: Tie the OSC I/E pin to "H", short the pins OSCR and OSC2, and leave the pin OSC1 open.
- External Rf oscillation mode: Tie the OSC I/E pin to "H", connect an external resistor Rf between the pins OSC1 and OSC2, and leave the pin OSCR open.
- External clock input mode: Tie the OSC I/E pin to "L", leave open the pins OSCR and OSC2, and input the external clock signal to the pin OSC1.



**In the Slave mode (M/S pin = "L"):**

Leave open the pins OSCR and OSC2 and connect the pin OSC1 to the COM OUT pin of the ML9060 which has been set in the master mode. The common signal that is input to the pin OSC1 will be used as the internal common signal and is also output via a buffer from the COM OUT pin.

**• COM OUT**

This is the common signal output pin. Connect this pin to the OSC1 pin of the ML9060 that is set in the slave mode.

During operation in the master mode (M/S pin = "H") for static display, a common signal with 1/128th the frequency of the oscillator is output.

During operation in the master mode (M/S pin = "H") for 1/2 duty dynamic display, a common signal with 1/64th the frequency of the oscillator is output.

During operation in the slave mode (M/S pin = "L"), the common signal that is input at the pin OSC1 is output from this pin via a buffer.

**• SYNC**

This is the I/O pin for common signal synchronization.

This pin becomes the synchronization signal output pin during operation in the master mode (M/S pin = "H") for 1/2 duty dynamic display.

This pin becomes the synchronization signal input pin during operation in the slave mode (M/S pin = "L") for 1/2 duty dynamic display.

For cascade operation in the 1/2 duty display mode, connect the SYNC pins of all ML9060 ICs used together.

During operation in the static display mode, this pin is tied to the "L" level inside the IC. Connect this pin either to GND or leave it open.

**• DATA IN**

This is the display data input pin. Input the display data in the sequence of SEG160, SEG159, ..., SEG2, SEG1. The segment is turned ON when the display data is "H" and OFF when "L".

**• DATA OUT**

This is the display data output pin. During the static display mode of operation, the data of the 160th stage of the shift register is output from this pin. During the 1/2 duty dynamic display mode, the data of the 320th stage of the shift register is output from this pin.

**• CLOCK IN**

This is the input pin for the shift clock of the display data. The display data that is input at the DATA IN pin is input serially to the shift register at the rising edge of the CLOCK IN signal. Also, the display data in the shift register is output from the DATA OUT pin at the falling edge of the CLOCK IN signal.

**• CLOCK OUT**

This is the output pin for the shift clock of the display data. The shift clock signal that is input to the CLOCK IN pin is output via a buffer from this pin.

**• LOAD IN**

This is the input pin for the display data load signal.

The display data in the shift register is output as such to the segment driver when this signal is at the "H" level. When this signal is made "L", the shift register is isolated from the segment drivers, and the display data of the shift register just before this pin goes "L" is retained in the data latches and transferred to the segment drivers.

**• LOAD OUT**

This is the output pin for the display data load signal. The load signal that is input to the LOAD IN pin is output from this pin via a buffer.

**• SEG-TEST IN**

This is the input pin for making all segments ON. When this pin is "H", all segment outputs (SEG1 to SEG160) become ON irrespective of the display data and the Blank signal. When this pin is made "L", each of the segment outputs (SEG1 to SEG160) become ON or OFF according to the display data.

**• SEG-TEST OUT**

This is the output pin for making all segments ON. The segment ON signal that is input to the SEG-TEST IN pin is output via a buffer.

**• BLANK IN**

This is the input pin for making all segments OFF. When this pin is "H", all segment outputs (SEG1 to SEG160) become OFF irrespective of the display data. When this pin is made "L", each of the segment outputs (SEG1 to SEG160) becomes ON or OFF according to the display data. The BLANK IN is valid when the segment ON signal is "L".

**• BLANK OUT**

This is the output pin for making all segments OFF. The segment OFF signal that is input to the BLANK IN pin is output via a buffer.

**• SEG1 to SEG160**

These are the signal outputs for driving the LCD segments and are connected to the corresponding segment pins of the LCD panel.

**In the Static display mode:**

The SEG<sub>n</sub> output corresponds to bit n of the display data in the data latch A. The display data in the data latch B becomes invalid. In the segment ON condition, a signal with a phase opposite to that of the COM OUT signal is output from these pins. In the segment OFF condition, a signal with a phase identical to that of the COM OUT signal is output from these pins.

**In the 1/2 duty dynamic display mode:**

The SEG<sub>n</sub> output corresponds to bit n of the display data in the data latch A when COM A has been selected and to bit n of the display data in the data latch B when COM B has been selected. In the segment display ON condition, a signal opposite in phase to that of the selected COM output is output from these pins. In the segment display OFF condition, a signal identical in phase to that of the selected COM output is output from these pins.

**• COM A, COM B**

These are the outputs for LCD display and are connected to the common pins of the LCD panel.

**In the Static display mode:**

COM A and COM B both output a signal with the same phase as that of the COM OUT signal.

**In the 1/2 duty dynamic display mode:**

COM A and COM B change their states at every cycle of the COM OUT signal and repeat the selected and non-selected modes always opposing each other in phase. A signal with the same phase as that of the COM OUT signal is output in the selected mode. A voltage equal to  $1/2V_{LCD}$  is output in the non-selected mode.

When COM A is in the selected mode (that is, COM B is in the non-selected mode), the segment outputs (SEG1 to SEG160) output signals corresponding to the display data in the data latch A. When COM B is in the selected mode (that is, COM A is in the non-selected mode), the segment outputs (SEG1 to SEG160) output signals corresponding to the display data in the data latch B.

**• V<sub>DD</sub>**

This is the power supply input pin for the logic circuits.

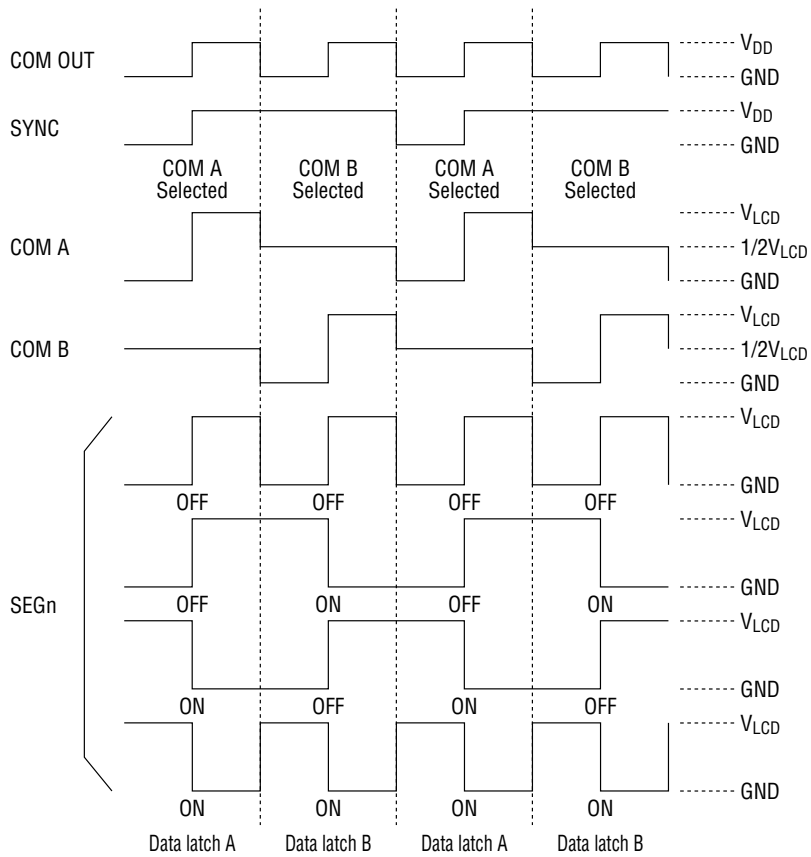
**• V<sub>LCD</sub>**

This is the power supply input pin for the LCD drivers.

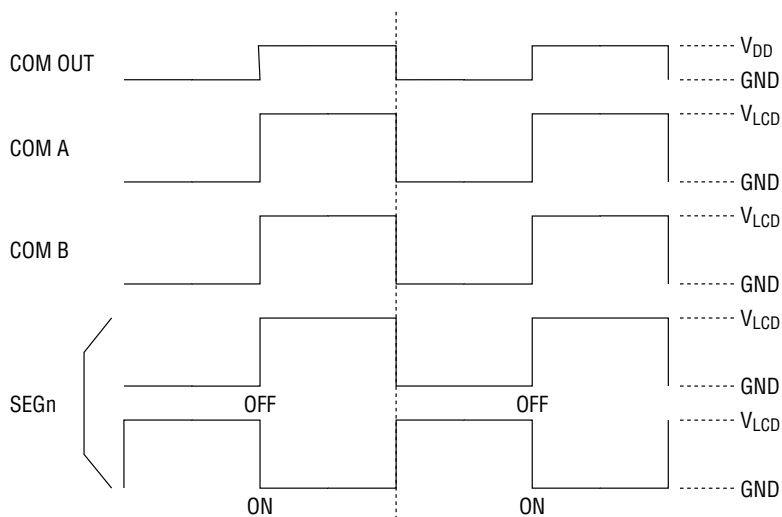
**• GND**

This is the ground pin for all circuits.

**Segment Output and Common Output Waveforms  
In the 1/2 duty display mode:**

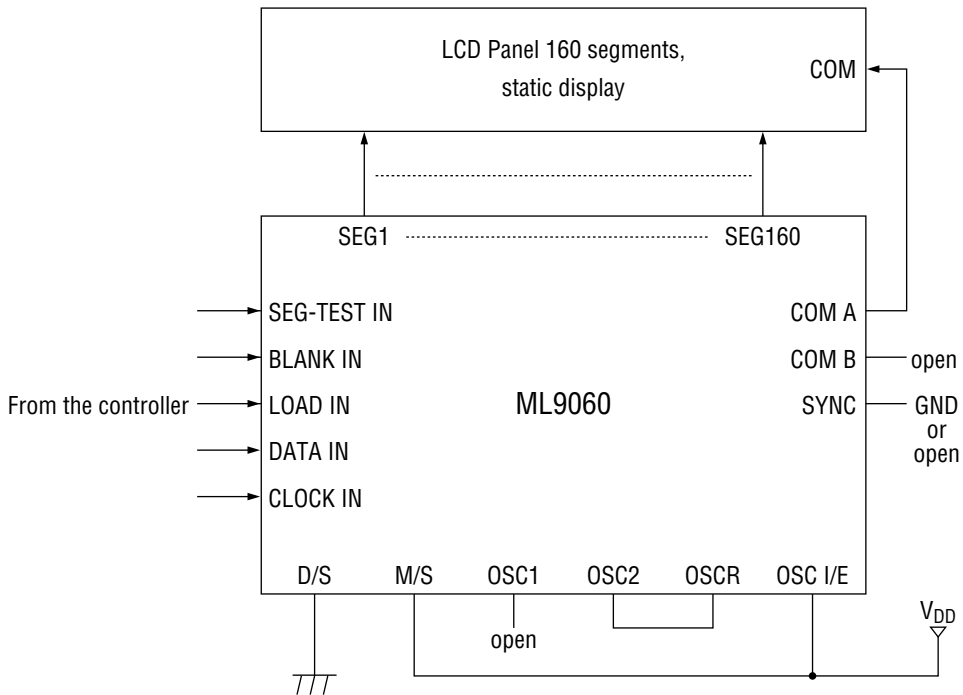


**In the static display mode:**

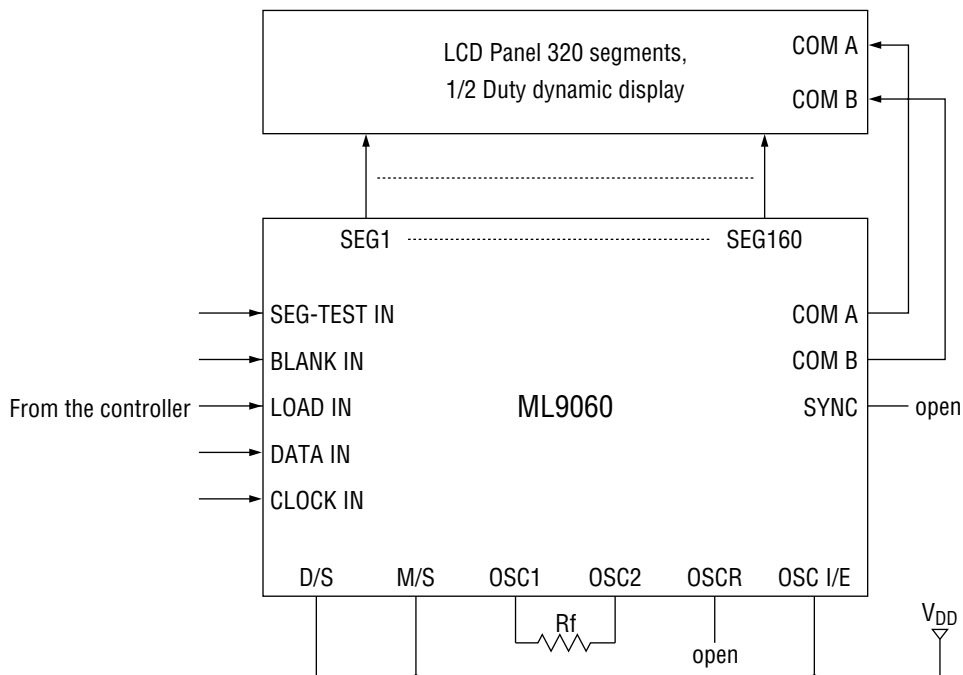


**APPLICATION CIRCUIT EXAMPLES**

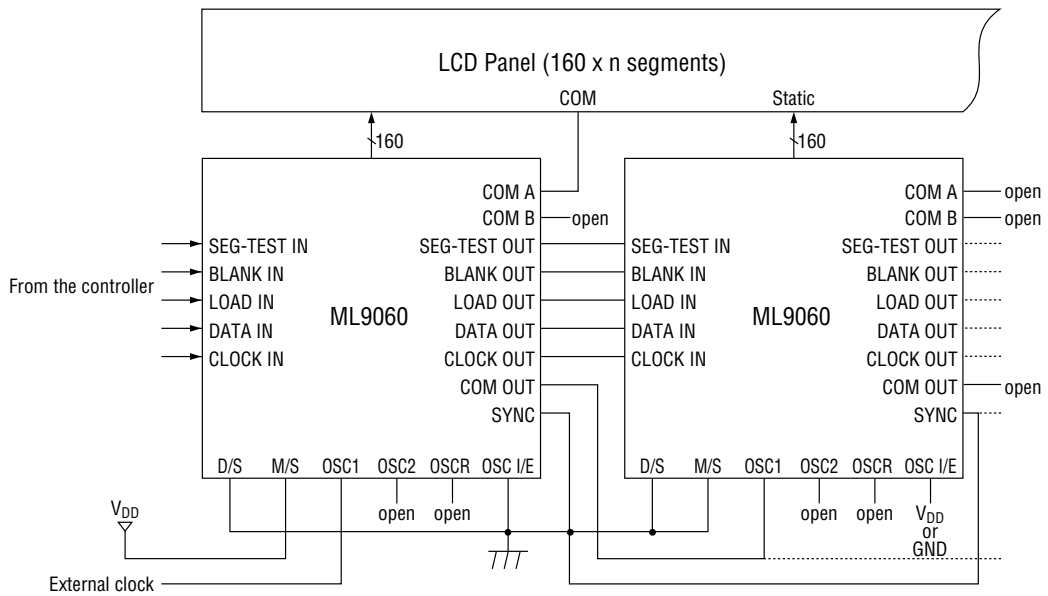
**When a single ML9060 is used - Static display mode (internal Rf oscillation mode)**



**When a single ML9060 is used - 1/2 duty dynamic display mode (external Rf oscillation mode)**

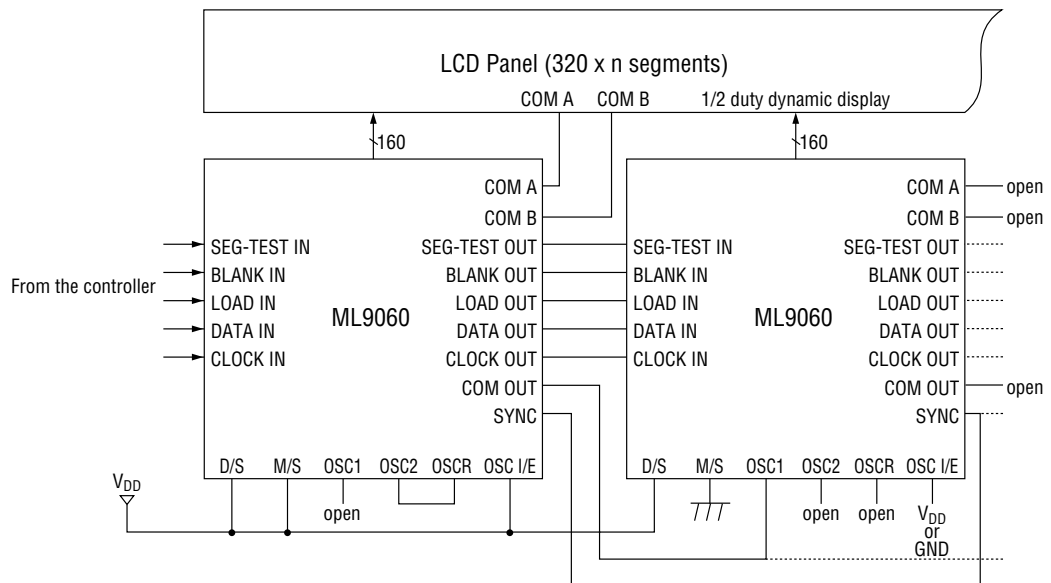


**Cascade Connection - Static display mode (external clock input mode)**



Note: Take care about the resistance and capacitance of wiring for cascade connection.

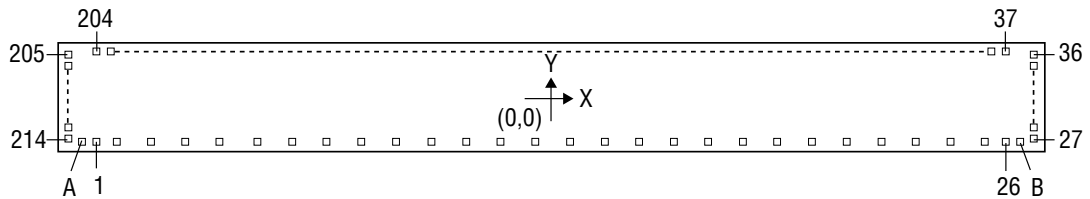
**Cascade Connection - 1/2 duty dynamic display mode (internal Rf oscillation mode)**



Note: Take care about the resistance and capacitance of wiring for cascade connection.

**PAD CONFIGURATION****Pad Layout (Pattern side)**

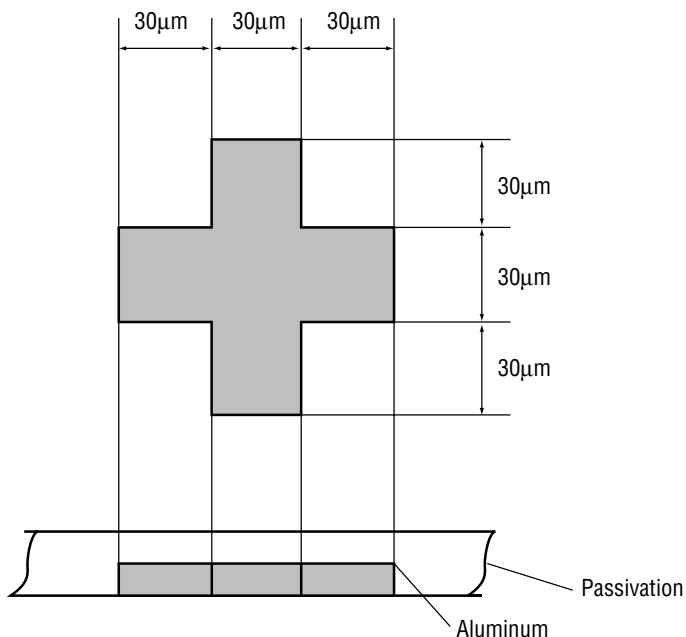
Chip size	: 14.50 × 1.63mm
Chip thickness	: 625 $\mu$ m ± 30 $\mu$ m
Minimum bump pitch	: 80 $\mu$ m
Bump height	: 15 $\mu$ m ± 5 $\mu$ m
Bump height inside the chip	: max. – min. ≤ 4 $\mu$ m
Bump hardness	: max. 100 (HV: 25 g LOAD)



\* : The substrate of the chip should either be connected to the GND level or be left open.

**Bump and Alignment Mark Dimensions (Pattern side)**

PAD No.1 to 26, 37 to 204	: 50 × 80 $\mu$ m
PAD No.27 to 36, 205 to 214	: 80 × 50 $\mu$ m
Alignment marks A and B	: Shown below



## Pad Center Coordinates

Pad No.	Pad name	X-coordinate ( $\mu\text{m}$ )	Y-coordinate ( $\mu\text{m}$ )	Pad No.	Pad name	X-coordinate ( $\mu\text{m}$ )	Y-coordinate ( $\mu\text{m}$ )
1	NC	-6680	-636	21	OSC2	4008	-636
2	NC	-6146	-636	22	OSCR	4542	-636
3	SYNC	-5611	-636	23	OSC1	5077	-636
4	NC	-5077	-636	24	NC	5611	-636
5	COMOUT	-4542	-636	25	NC	6146	-636
6	NC	-4008	-636	26	NC	6680	-636
7	V <sub>LCD</sub>	-3474	-636	27	NC	7121	-435
8	V <sub>LCD</sub>	-2939	-636	28	NC	7121	-355
9	V <sub>LCD</sub>	-2405	-636	29	DATA IN	7121	-275
10	NC	-1870	-636	30	NC	7121	-195
11	GND	-1336	-636	31	CLOCK IN	7121	-115
12	GND	-802	-636	32	LOAD IN	7121	-35
13	GND	-267	-636	33	SEG-TEST IN	7121	45
14	D/S	267	-636	34	BLANK IN	7121	125
15	OSC I/E	802	-636	35	NC	7121	205
16	M/S	1336	-636	36	NC	7121	285
17	V <sub>DD</sub>	1870	-636	37	NC	6680	636
18	V <sub>DD</sub>	2405	-636	38	NC	6600	636
19	V <sub>DD</sub>	2939	-636	39	NC	6520	636
20	NC	3474	-636	40	COMA	6440	636

NC: No Connection



Pad No.	Pad name	X-coordinate ( $\mu\text{m}$ )	Y-coordinate ( $\mu\text{m}$ )	Pad No.	Pad name	X-coordinate ( $\mu\text{m}$ )	Y-coordinate ( $\mu\text{m}$ )
41	COM B	6360	636	86	SEG45	2760	636
42	SEG1	6280	636	87	SEG46	2680	636
43	SEG2	6200	636	88	SEG47	2600	636
44	SEG3	6120	636	89	SEG48	2520	636
45	SEG4	6040	636	90	SEG49	2440	636
46	SEG5	5960	636	91	SEG50	2360	636
47	SEG6	5880	636	92	SEG51	2280	636
48	SEG7	5800	636	93	SEG52	2200	636
49	SEG8	5720	636	94	SEG53	2120	636
50	SEG9	5640	636	95	SEG54	2040	636
51	SEG10	5560	636	96	SEG55	1960	636
52	SEG11	5480	636	97	SEG56	1880	636
53	SEG12	5400	636	98	SEG57	1800	636
54	SEG13	5320	636	99	SEG58	1720	636
55	SEG14	5240	636	100	SEG59	1640	636
56	SEG15	5160	636	101	SEG60	1560	636
57	SEG16	5080	636	102	SEG61	1480	636
58	SEG17	5000	636	103	SEG62	1400	636
59	SEG18	4920	636	104	SEG63	1320	636
60	SEG19	4840	636	105	SEG64	1240	636
61	SEG20	4760	636	106	SEG65	1160	636
62	SEG21	4680	636	107	SEG66	1080	636
63	SEG22	4600	636	108	SEG67	1000	636
64	SEG23	4520	636	109	SEG68	920	636
65	SEG24	4440	636	110	SEG69	840	636
66	SEG25	4360	636	111	SEG70	760	636
67	SEG26	4280	636	112	SEG71	680	636
68	SEG27	4200	636	113	SEG72	600	636
69	SEG28	4120	636	114	SEG73	520	636
70	SEG29	4040	636	115	SEG74	440	636
71	SEG30	3960	636	116	SEG75	360	636
72	SEG31	3880	636	117	SEG76	280	636
73	SEG32	3800	636	118	SEG77	200	636
74	SEG33	3720	636	119	SEG78	120	636
75	SEG34	3640	636	120	SEG79	40	636
76	SEG35	3560	636	121	SEG80	-40	636
77	SEG36	3480	636	122	SEG81	-120	636
78	SEG37	3400	636	123	SEG82	-200	636
79	SEG38	3320	636	124	SEG83	-280	636
80	SEG39	3240	636	125	SEG84	-360	636
81	SEG40	3160	636	126	SEG85	-440	636
82	SEG41	3080	636	127	SEG86	-520	636
83	SEG42	3000	636	128	SEG87	-600	636
84	SEG43	2920	636	129	SEG88	-680	636
85	SEG44	2840	636	130	SEG89	-760	636

Pad No.	Pad name	X-coordinate ( $\mu\text{m}$ )	Y-coordinate ( $\mu\text{m}$ )	Pad No.	Pad name	X-coordinate ( $\mu\text{m}$ )	Y-coordinate ( $\mu\text{m}$ )
131	SEG90	-840	636	176	SEG135	-4440	636
132	SEG91	-920	636	177	SEG136	-4520	636
133	SEG92	-1000	636	178	SEG137	-4600	636
134	SEG93	-1080	636	179	SEG138	-4680	636
135	SEG94	-1160	636	180	SEG139	-4760	636
136	SEG95	-1240	636	181	SEG140	-4840	636
137	SEG96	-1320	636	182	SEG141	-4920	636
138	SEG97	-1400	636	183	SEG142	-5000	636
139	SEG98	-1480	636	184	SEG143	-5080	636
140	SEG99	-1560	636	185	SEG144	-5160	636
141	SEG100	-1640	636	186	SEG145	-5240	636
142	SEG101	-1720	636	187	SEG146	-5320	636
143	SEG102	-1800	636	188	SEG147	-5400	636
144	SEG103	-1880	636	189	SEG148	-5480	636
145	SEG104	-1960	636	190	SEG149	-5560	636
146	SEG105	-2040	636	191	SEG150	-5640	636
147	SEG106	-2120	636	192	SEG151	-5720	636
148	SEG107	-2200	636	193	SEG152	-5800	636
149	SEG108	-2280	636	194	SEG153	-5880	636
150	SEG109	-2360	636	195	SEG154	-5960	636
151	SEG110	-2440	636	196	SEG155	-6040	636
152	SEG111	-2520	636	197	SEG156	-6120	636
153	SEG112	-2600	636	198	SEG157	-6200	636
154	SEG113	-2680	636	199	SEG158	-6280	636
155	SEG114	-2760	636	200	SEG159	-6360	636
156	SEG115	-2840	636	201	SEG160	-6440	636
157	SEG116	-2920	636	202	NC	-6520	636
158	SEG117	-3000	636	203	NC	-6600	636
159	SEG118	-3080	636	204	NC	-6680	636
160	SEG119	-3160	636	205	NC	-7121	285
161	SEG120	-3240	636	206	NC	-7121	205
162	SEG121	-3320	636	207	BLANKOUT	-7121	125
163	SEG122	-3400	636	208	SEG-TESTOUT	-7121	45
164	SEG123	-3480	636	209	LOADOUT	-7121	-35
165	SEG124	-3560	636	210	CLOCKOUT	-7121	-115
166	SEG125	-3640	636	211	NC	-7121	-195
167	SEG126	-3720	636	212	DATAOUT	-7121	-275
168	SEG127	-3800	636	213	NC	-7121	-355
169	SEG128	-3880	636	214	NC	-7121	-435
170	SEG129	-3960	636				
171	SEG130	-4040	636	A	'+' ALIGN	-6980	-640
172	SEG131	-4120	636	B	'+' ALIGN	6980	-640
173	SEG132	-4200	636				
174	SEG133	-4280	636				
175	SEG134	-4360	636				

**NOTICE**

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